

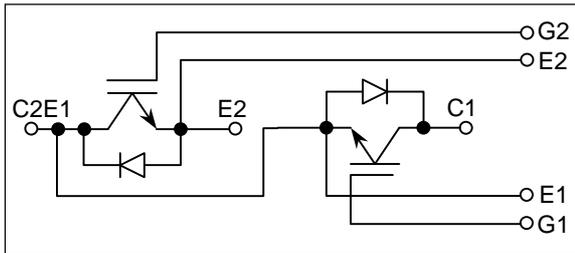
MBM150GR12A

[Rated 150A/1200V, Dual-pack type]

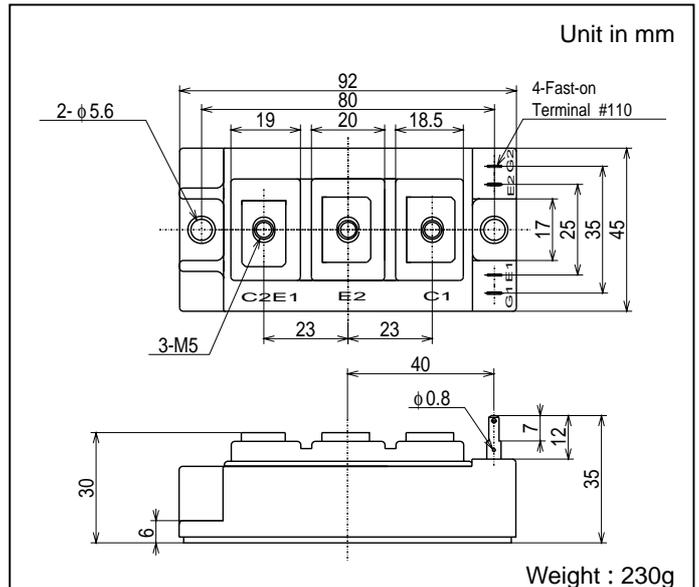
FEATURES

- Low saturation voltage and high speed.
- Low turn-OFF switching loss.
- Low noise due to built-in free-wheeling diode.
(Ultra Soft and Fast recovery Diode (USFD))
- High reliability structure.
- Isolated heat sink (terminals to base).

CIRCUIT DIAGRAM



OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS (T_c=25°C)

Item	Symbol	Unit	Value
Collector-Emitter Voltage	V _{CEs}	V	1200
Gate-Emitter Voltage	V _{GES}	V	±20
Collector Current	DC	I _C	150
	1ms	I _{CP}	300
Forward Current	DC	I _F	150 ^{*1}
	1ms	I _{FM}	300
Collector Power Dissipation	P _C	W	1000
Junction Temperature	T _j	°C	-40 ~ +150
Storage Temperature	T _{stg}	°C	-40 ~ +125
Isolation Voltage	V _{iso}	V _{RMS}	2500(AC 1 minute)
Screw Torque	Terminals	—	1.96 ^{*2}
	Mounting		1.96 ^{*3}

Notes; *1 : RMS current of diode ≤ 45 Arms

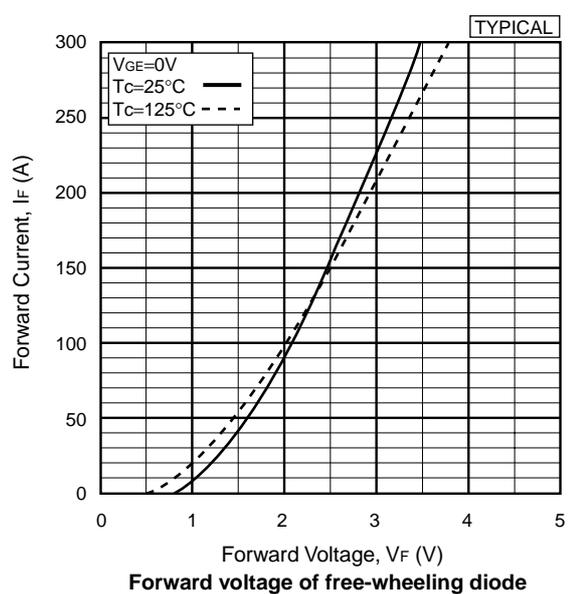
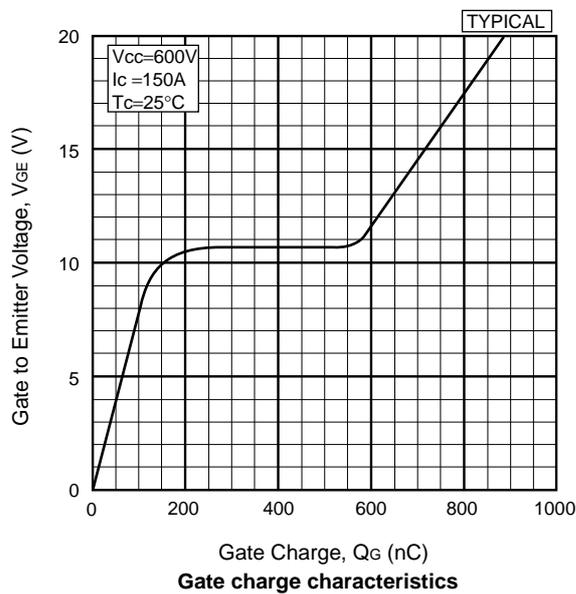
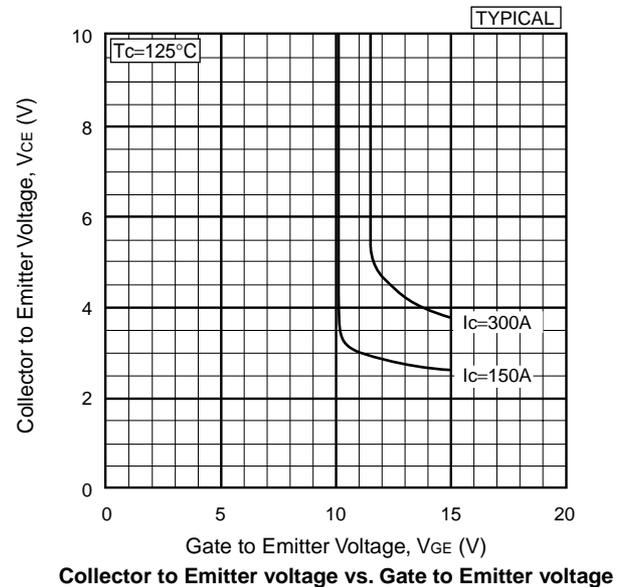
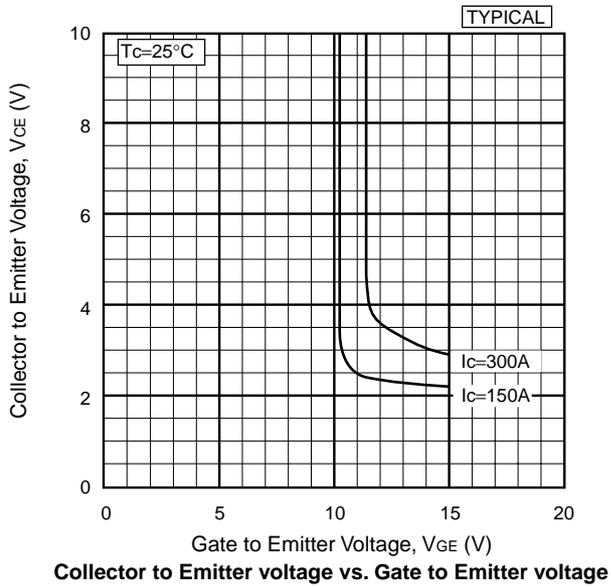
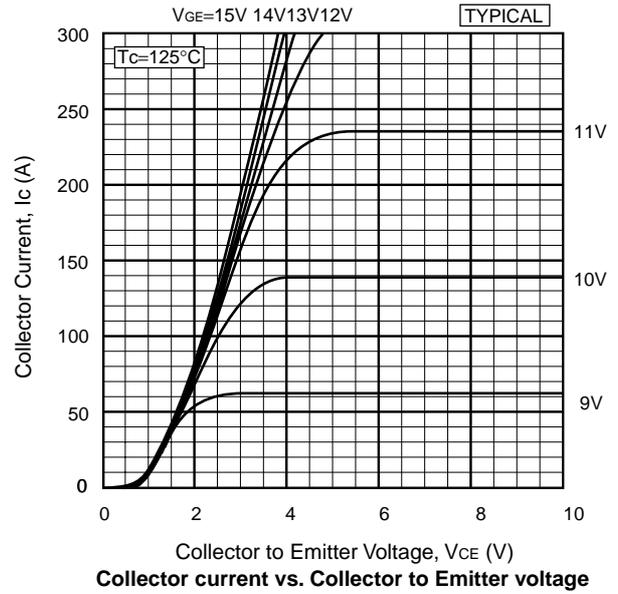
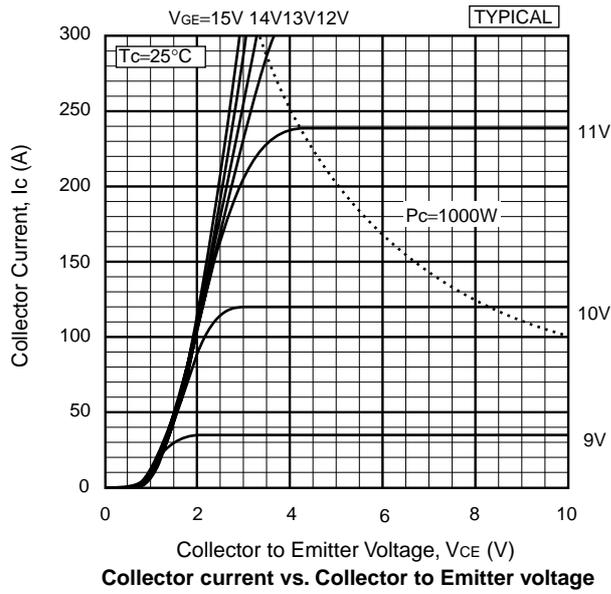
*2, *3 : Recommended value 1.67 N·m

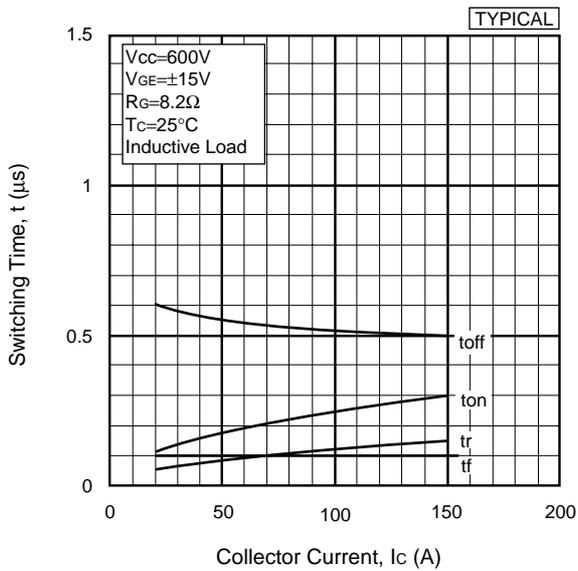
CHARACTERISTICS (T_c=25°C)

Item	Symbol	Unit	Min.	Typ.	Max.	Test Conditions	
Collector-Emitter Cut-Off Current	I _{CEs}	mA	—	—	1.0	V _{CE} =1200V, V _{GE} =0V	
Gate-Emitter Leakage Current	I _{GES}	nA	—	—	±500	V _{GE} =±20V, V _{CE} =0V	
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V	—	2.2	2.8	I _C =150A, V _{GE} =15V	
Gate-Emitter Threshold Voltage	V _{GE(TO)}	V	—	—	10	V _{CE} =5V, I _C =150mA	
Input Capacitance	C _{ies}	pF	—	12000	—	V _{CE} =10V, V _{GE} =0V, f=1MHz	
Switching Times	Rise Time	t _r	—	0.15	0.3	V _{CC} =600V, I _C =150A R _G =8.2Ω ^{*4} V _{GE} =±15V Inductive Load I _F =150A	
	Turn-On Time	t _{on}	—	0.3	0.6		
	Fall Time	t _f	—	0.1	0.3		
	Turn-Off Time	t _{off}	—	0.5	1.0		
Reverse Recovery Time	t _{rr}	μs	—	0.2	0.4		
Peak Forward Voltage Drop	V _{FM}	V	—	2.5	3.5	I _F =150A, V _{GE} =0V	
Thermal Impedance	IGBT	R _{th(j-c)}	°C/W	—	—	0.125	Junction to case
	FWD	R _{th(j-c)}					

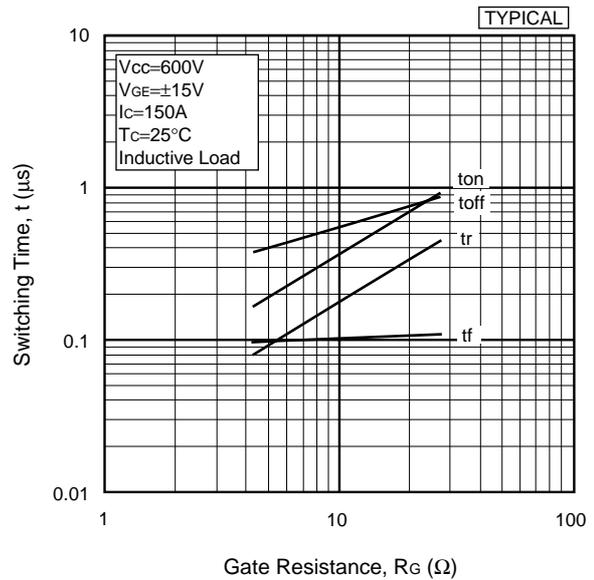
Notes; *4 : R_G value is the test condition's value for decision of the switching times, not recommended value, please determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage, etc.) with appliance mounted.

Remark; For actual application, please confirm this spec. sheet is the newest revision.

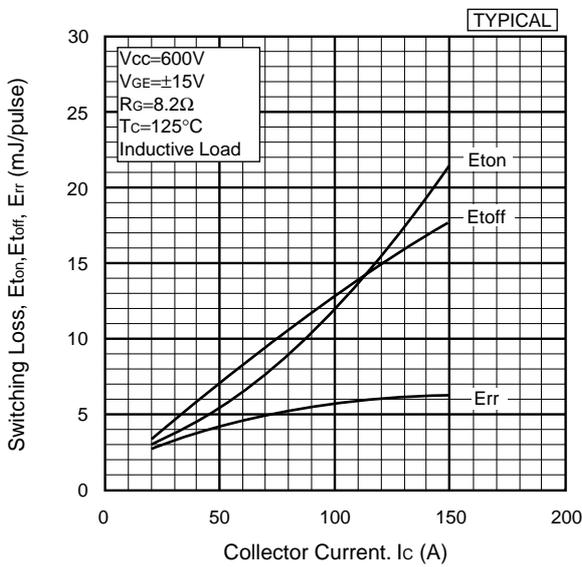




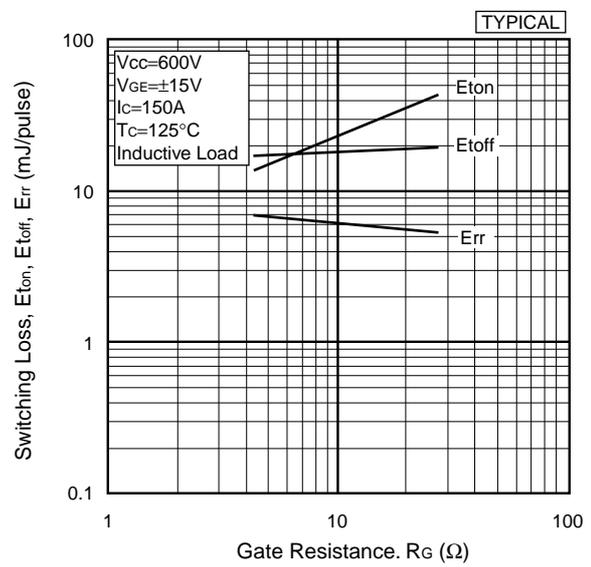
Switching time vs. Collector current



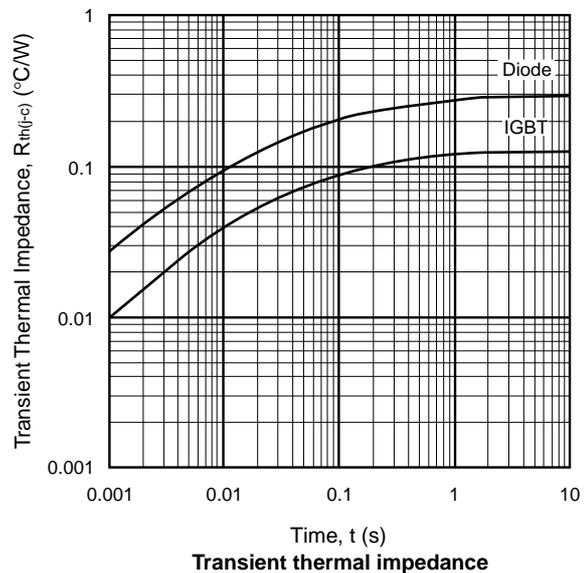
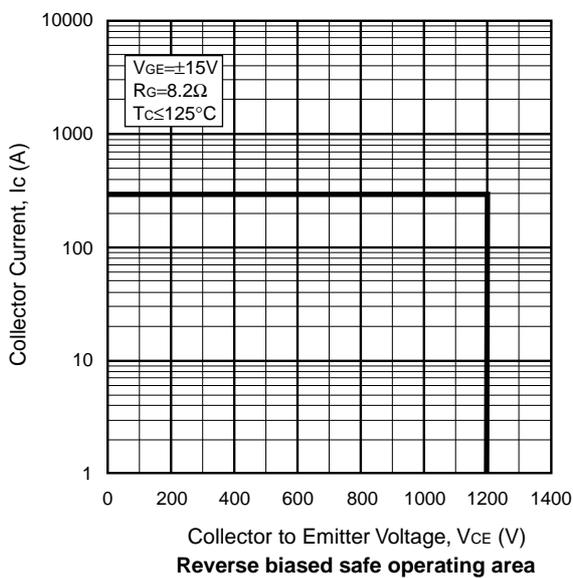
Switching time vs. Gate resistance



Switching loss vs. Collector current



Switching loss vs. Gate resistance



HITACHI POWER SEMICONDUCTORS

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